



# NGW40T65H3DHP

650 V, 40 A trench field-stop IGBT with half rated silicon diode

Rev. 1 — 17 January 2025

Product data sheet

## 1. General description

The NGW40T65H3DHP is a robust Insulated-Gate Bipolar Transistor (IGBT) featuring third-generation technology. It combines carrier stored trench-gate and field-stop (FS) structures. The NGW40T65H3DHP is rated to 175 °C with optimized IGBT turn-off losses. This hard-switching 650 V, 40 A IGBT is optimized for high-voltage, high-frequency industrial power inverter applications.

## 2. Features

- IGBT collector current is rated at 40 A, diode forward current is rated at 20 A
- Low conduction and switching losses
- Stable and tight parameters for easy parallel operation
- Maximum junction temperature 175 °C
- Fully rated and fast reverse recovery diode
- HV-H3TRB qualified

## 3. Applications

- Power inverters such as
  - Uninterruptible Power Supply (UPS) inverter
  - EV charging converter
- Power Factor Correction (PFC)
- Induction heating
- Welding

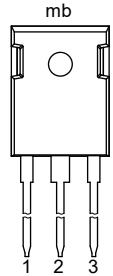
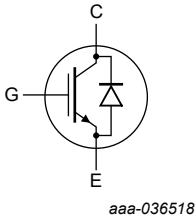
## 4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CES}$	collector-emitter voltage	$T_{vj} = 25\text{ °C}$	-	650	V
$T_{vj}$	operating junction temperature		-40	175	°C

## 5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate		
2	C	collector		
3	E	emitter		
mb	C	mounting base; connected to collector		

## 6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
<a href="#">NGW40T65H3DHP</a>	TO-247-3L	Plastic single-ended through-hole package; heatsink mounted; 1 mounting hole; 3-lead TO-247-3L	<a href="#">SOT429-2</a>

## 7. Limiting values

Table 4. Limiting values

Symbol	Parameter	Conditions	Min	Max	Unit
<b>IGBT</b>					
$V_{CES}$	collector-emitter voltage	$T_{vj} = 25\text{ °C}$	-	650	V
$I_C$	collector current	[1] $T_c = 25\text{ °C}$	-	72	A
		$T_c = 100\text{ °C}$	-	47	A
$I_{CRM}$	repetitive peak collector current	[2]	-	160	A
$V_{GE}$	gate-emitter voltage		-20	20	V
$P_{tot}$	total power dissipation	$T_c = 25\text{ °C}$	-	275	W
		$T_c = 100\text{ °C}$	-	138	W
$T_{vj}$	operating junction temperature		-40	175	°C
$T_{stg}$	storage temperature		-55	150	°C
$T_{solder}$	soldering temperature		-	260	°C
<b>Diode</b>					
$I_F$	diode forward current	[1] $T_c = 25\text{ °C}$	-	36	A
		$T_c = 100\text{ °C}$	-	21	A
$I_{FRM}$	repetitive peak forward current	[2]	-	80	A

[1] Value is limited by bondwire and  $T_{vj(max)}$ .

[2] Time duration is limited by  $T_{vj(max)}$ .

## 8. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
M	mounting torque, M3 screw		-	0.6	-	Nm
$R_{th(j-c)}$	thermal resistance from junction to case	IGBT	-	0.46	0.54	K/W
		diode	-	1.71	2.02	K/W
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	-	-	40	K/W

## 9. Electrical characteristics

Table 6. Characteristics

All values at  $T_{vj} = 25\text{ °C}$ , unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>Static characteristics</b>						
$V_{(BR)CES}$	collector-emitter breakdown voltage	$V_{GE} = 0\text{ V}; I_C = 0.2\text{ mA}$	650	-	-	V
$V_{CEsat}$	collector-emitter saturation voltage	$V_{GE} = 15\text{ V}; I_C = 40\text{ A}; T_{vj} = 25\text{ °C}$	-	1.69	2.0	V
		$V_{GE} = 15\text{ V}; I_C = 40\text{ A}; T_{vj} = 175\text{ °C}$	-	2.22	-	V
$V_F$	diode forward voltage	$V_{GE} = 0\text{ V}; I_F = 20\text{ A}; T_{vj} = 25\text{ °C}$	-	1.69	2.0	V
		$V_{GE} = 0\text{ V}; I_F = 20\text{ A}; T_{vj} = 175\text{ °C}$	-	1.43	-	V
$V_{GE(th)}$	gate-emitter threshold voltage	$I_C = 0.4\text{ mA}; V_{CE} = V_{GE}; T_{vj} = 25\text{ °C}$	4.3	5.0	5.7	V
$I_{CES}$	zero gate voltage collector current	$V_{CE} = 650\text{ V}; V_{GE} = 0\text{ V}; T_{vj} = 25\text{ °C}$	-	4	-	nA
		$V_{CE} = 650\text{ V}; V_{GE} = 0\text{ V}; T_{vj} = 175\text{ °C}$	-	0.3	-	mA
$I_{GES}$	gate-emitter leakage current	$V_{CE} = 0\text{ V}; V_{GE} = 20\text{ V}$	-	-	100	nA
$g_{fs}$	transconductance	$V_{CE} = 20\text{ V}; I_C = 40\text{ A}; T_{vj} = 25\text{ °C}$	-	23.2	-	S
$r_g$	internal gate resistor		-	2.1	-	$\Omega$
<b>Dynamic characteristics</b>						
$C_{ies}$	input capacitance	$V_{CE} = 25\text{ V}; V_{GE} = 0\text{ V}; f = 1\text{ MHz}$	-	1760	-	pF
$C_{oes}$	output capacitance		-	100	-	pF
$C_{res}$	reverse transfer capacitance		-	15	-	pF
$Q_G$	gate charge	$V_{CC} = 520\text{ V}; V_{GE} = 15\text{ V}; I_C = 40\text{ A}$	-	61	-	nC
$L_{sCE}$	internal stray inductance	measured 5 mm from case	-	7.9	-	nH

## 650 V, 40 A trench field-stop IGBT with half rated silicon diode

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>IGBT switching characteristics, inductive load</b>						
$t_{d(on)}$	turn-on delay time	$V_{GE} = 15/0\text{ V}; V_{CC} = 400\text{ V};$ $I_C = 40\text{ A}; R_{G(on)} = 10\ \Omega;$ $R_{G(off)} = 10\ \Omega;$ see <a href="#">Fig. 27</a> and <a href="#">Fig. 28</a>	$T_{vj} = 25\text{ }^\circ\text{C}$	-	17	- ns
			$T_{vj} = 175\text{ }^\circ\text{C}$	-	16	- ns
$t_r$	rise time		$T_{vj} = 25\text{ }^\circ\text{C}$	-	28	- ns
			$T_{vj} = 175\text{ }^\circ\text{C}$	-	31	- ns
$t_{d(off)}$	turn-off delay time		$T_{vj} = 25\text{ }^\circ\text{C}$	-	76	- ns
			$T_{vj} = 175\text{ }^\circ\text{C}$	-	96	- ns
$t_f$	fall time		$T_{vj} = 25\text{ }^\circ\text{C}$	-	27	- ns
			$T_{vj} = 175\text{ }^\circ\text{C}$	-	38	- ns
$E_{on}$	turn-on switching energy loss		$T_{vj} = 25\text{ }^\circ\text{C}$	-	1.02	- mJ
			$T_{vj} = 175\text{ }^\circ\text{C}$	-	1.80	- mJ
$E_{off}$	turn-off switching energy loss		$T_{vj} = 25\text{ }^\circ\text{C}$	-	0.34	- mJ
			$T_{vj} = 175\text{ }^\circ\text{C}$	-	0.60	- mJ
$E_{ts}$	total switching energy loss		$T_{vj} = 25\text{ }^\circ\text{C}$	-	1.36	- mJ
			$T_{vj} = 175\text{ }^\circ\text{C}$	-	2.40	- mJ
<b>Diode switching characteristics, inductive load</b>						
$t_{rr}$	reverse recovery time	$V_R = 400\text{ V}; I_F = 20\text{ A};$ $di_F/dt = 500\text{ A}/\mu\text{s};$ see <a href="#">Fig. 26</a>	$T_{vj} = 25\text{ }^\circ\text{C}$	-	96	- ns
			$T_{vj} = 175\text{ }^\circ\text{C}$	-	191	- ns
$Q_{rr}$	reverse recovery charge		$T_{vj} = 25\text{ }^\circ\text{C}$	-	550	- nC
			$T_{vj} = 175\text{ }^\circ\text{C}$	-	1863	- nC
$I_{rrm}$	peak reverse recovery current		$T_{vj} = 25\text{ }^\circ\text{C}$	-	14	- A
			$T_{vj} = 175\text{ }^\circ\text{C}$	-	25	- A
$E_{rec}$	reverse recovery energy loss		$T_{vj} = 25\text{ }^\circ\text{C}$	-	0.07	- mJ
			$T_{vj} = 175\text{ }^\circ\text{C}$	-	0.31	- mJ
$di_{rrf}/dt$	fall rate of reverse recovery current		$T_{vj} = 25\text{ }^\circ\text{C}$	-	276	- A/ $\mu\text{s}$
			$T_{vj} = 175\text{ }^\circ\text{C}$	-	217	- A/ $\mu\text{s}$

9.1. Characteristic diagrams

Table 7. Waveforms and output characteristics

Fig. 1. Power dissipation as a function of case temperature

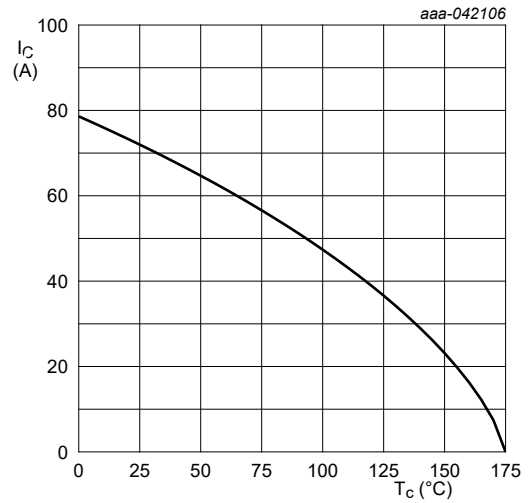
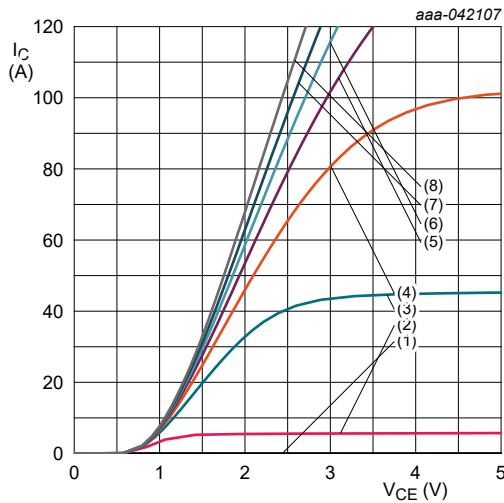


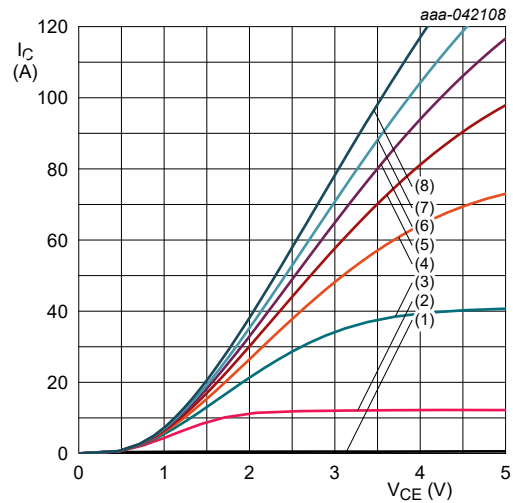
Fig. 2. Collector current as a function of case temperature



$T_{vj} = 25\text{ °C}$

- (1)  $V_{GE} = 5\text{ V}$
- (2)  $V_{GE} = 7\text{ V}$
- (3)  $V_{GE} = 9\text{ V}$
- (4)  $V_{GE} = 11\text{ V}$
- (5)  $V_{GE} = 13\text{ V}$
- (6)  $V_{GE} = 15\text{ V}$
- (7)  $V_{GE} = 17\text{ V}$
- (8)  $V_{GE} = 20\text{ V}$

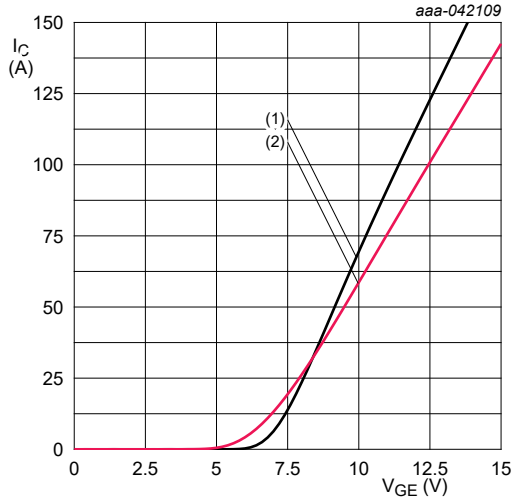
Fig. 3. Collector current as a function of collector-emitter voltage



$T_{vj} = 175\text{ °C}$

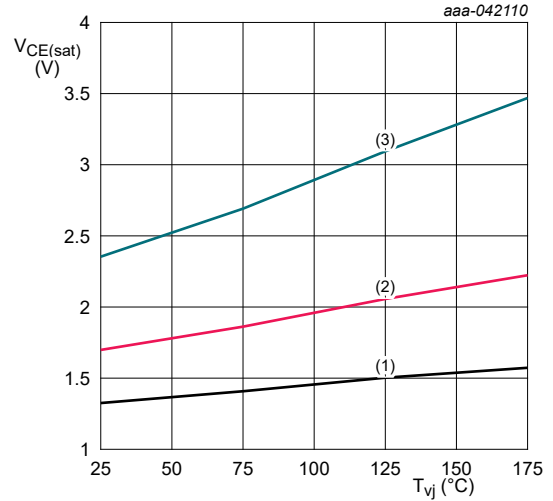
- (1)  $V_{GE} = 5\text{ V}$
- (2)  $V_{GE} = 7\text{ V}$
- (3)  $V_{GE} = 9\text{ V}$
- (4)  $V_{GE} = 11\text{ V}$
- (5)  $V_{GE} = 13\text{ V}$
- (6)  $V_{GE} = 15\text{ V}$
- (7)  $V_{GE} = 17\text{ V}$
- (8)  $V_{GE} = 20\text{ V}$

Fig. 4. Collector current as a function of collector-emitter voltage



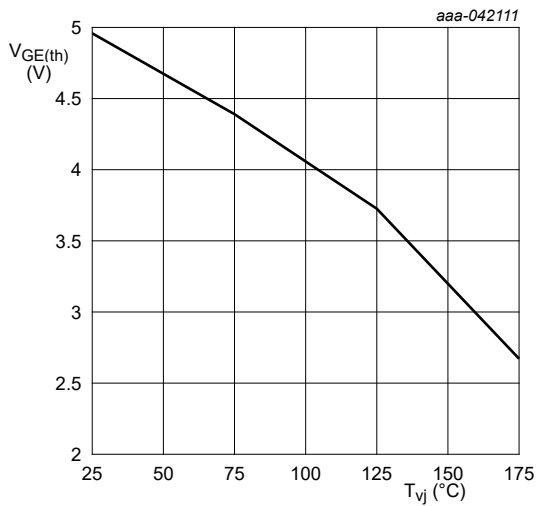
$V_{CE} = 20$  V  
 (1)  $T_{vj} = 25$  °C  
 (2)  $T_{vj} = 175$  °C

**Fig. 5. Collector current as a function of gate-emitter voltage**

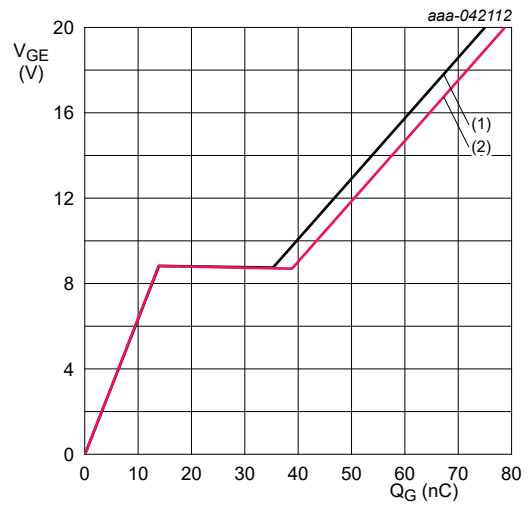


$V_{GE} = 15$  V  
 (1)  $I_C = 20$  A  
 (2)  $I_C = 40$  A  
 (3)  $I_C = 80$  A

**Fig. 6. Collector-emitter saturation voltage as a function of junction temperature**

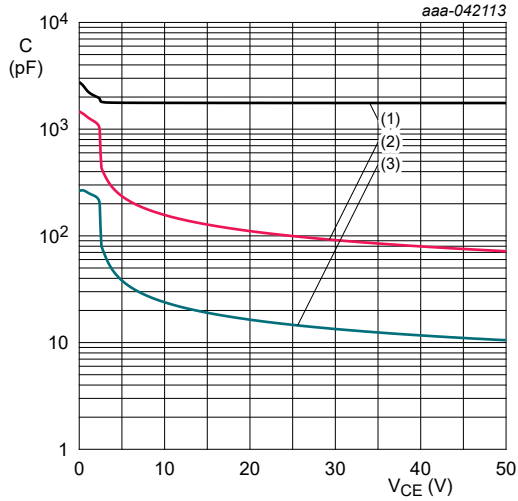


**Fig. 7. Gate-emitter threshold voltage as a function of junction temperature**



$I_C = 40$  A  
 (1)  $V_{CE} = 130$  V  
 (2)  $V_{CE} = 520$  V

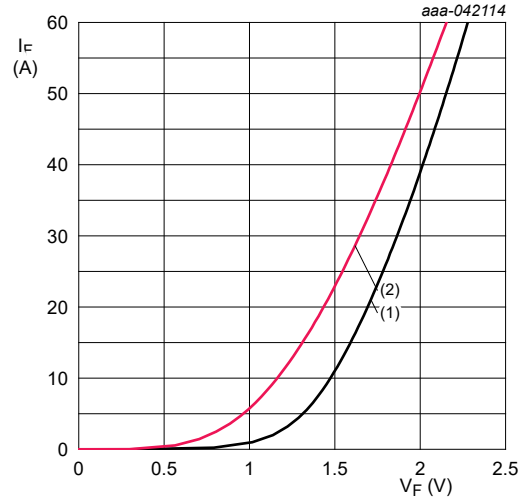
**Fig. 8. Gate-emitter voltage as a function of gate charge**



$V_{GE} = 0 \text{ V}; f = 1 \text{ MHz}$

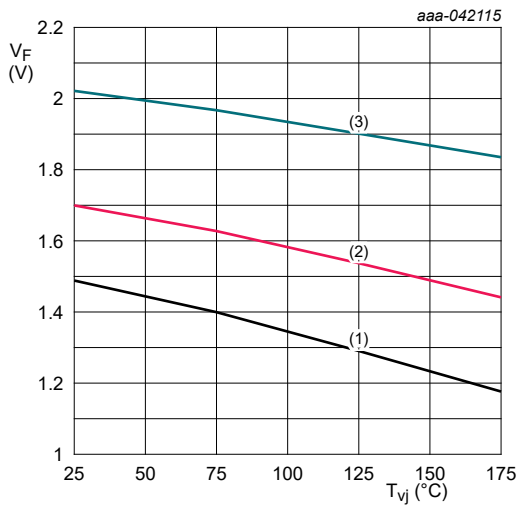
- (1)  $C_{ies}$
- (2)  $C_{oes}$
- (3)  $C_{res}$

**Fig. 9. Typical capacitance as a function of collector-emitter voltage**



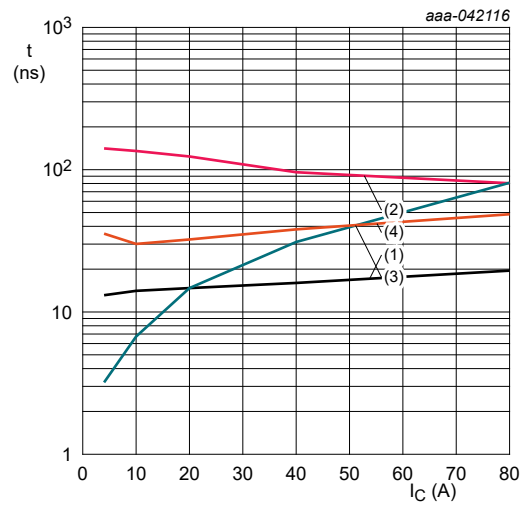
- (1)  $T_{vj} = 25 \text{ }^\circ\text{C}$
- (2)  $T_{vj} = 175 \text{ }^\circ\text{C}$

**Fig. 10. Typical diode forward current as a function of forward voltage**



- (1)  $I_F = 10 \text{ A}$
- (2)  $I_F = 20 \text{ A}$
- (3)  $I_F = 40 \text{ A}$

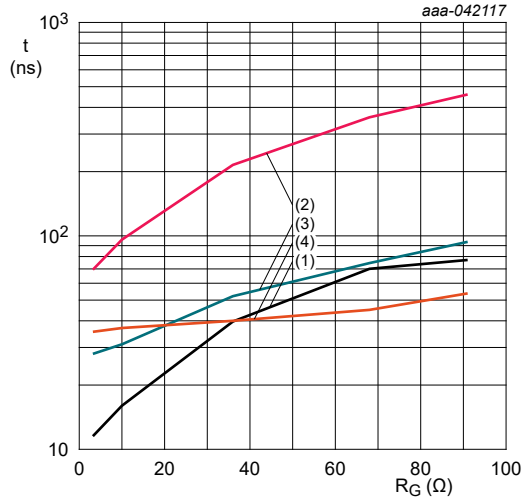
**Fig. 11. Typical diode forward voltage as a function of junction temperature**



$V_{GE} = 15 \text{ V to } 0 \text{ V}; V_{CC} = 400 \text{ V}; R_{G(on)} = 10 \text{ } \Omega;$   
 $R_{G(off)} = 10 \text{ } \Omega; T_{vj} = 175 \text{ }^\circ\text{C}$

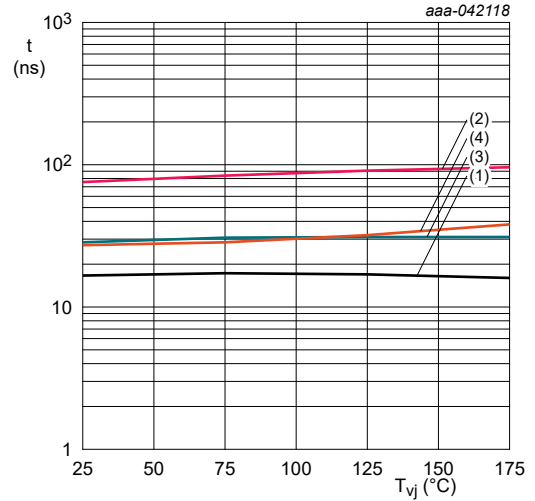
- (1)  $t_{d(on)}$
- (2)  $t_{d(off)}$
- (3)  $t_r$
- (4)  $t_f$

**Fig. 12. Typical switching times as a function of collector current**



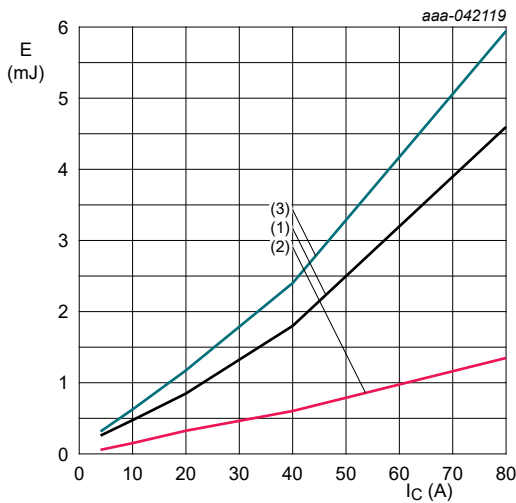
$V_{GE} = 15\text{ V to }0\text{ V}; V_{CC} = 400\text{ V}; I_C = 40\text{ A};$   
 $T_{vj} = 175\text{ }^\circ\text{C}$   
 (1)  $t_{d(on)}$   
 (2)  $t_{d(off)}$   
 (3)  $t_r$   
 (4)  $t_f$

Fig. 13. Typical switching times as a function of gate resistance



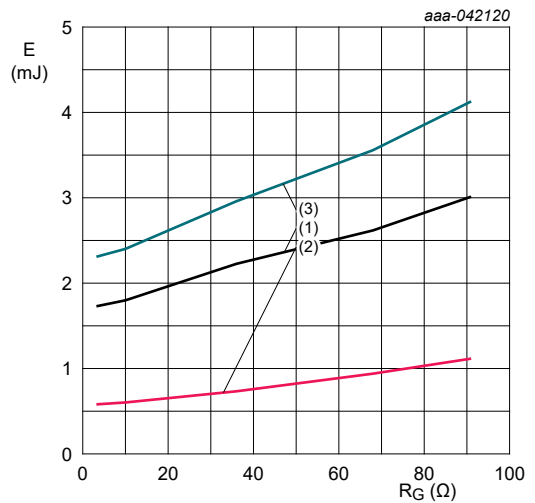
$V_{GE} = 15\text{ V to }0\text{ V}; I_C = 40\text{ A}; V_{CC} = 400\text{ V};$   
 $R_{G(on)} = 10\text{ }^\Omega; R_{G(off)} = 10\text{ }^\Omega$   
 (1)  $t_{d(on)}$   
 (2)  $t_{d(off)}$   
 (3)  $t_r$   
 (4)  $t_f$

Fig. 14. Typical switching times as a function of junction temperature



$V_{GE} = 15\text{ V to }0\text{ V}; V_{CC} = 400\text{ V}; R_{G(on)} = 10\text{ }^\Omega;$   
 $R_{G(off)} = 10\text{ }^\Omega; T_{vj} = 175\text{ }^\circ\text{C}$   
 (1)  $E_{on}$   
 (2)  $E_{off}$   
 (3)  $E_{ts}$

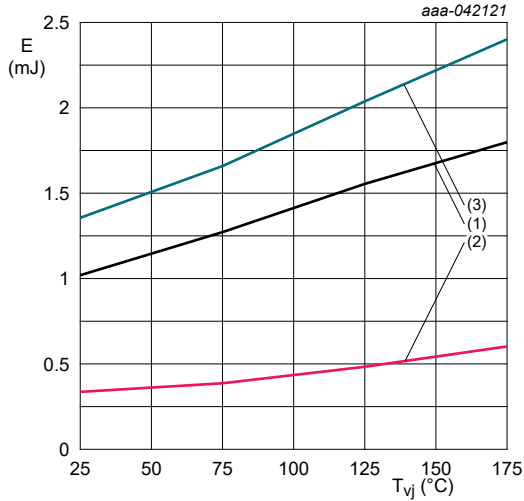
Fig. 15. Typical switching energy losses as a function of collector current



$V_{GE} = 15\text{ V to }0\text{ V}; V_{CC} = 400\text{ V}; I_C = 40\text{ A};$   
 $T_{vj} = 175\text{ }^\circ\text{C}$   
 (1)  $E_{on}$   
 (2)  $E_{off}$   
 (3)  $E_{ts}$

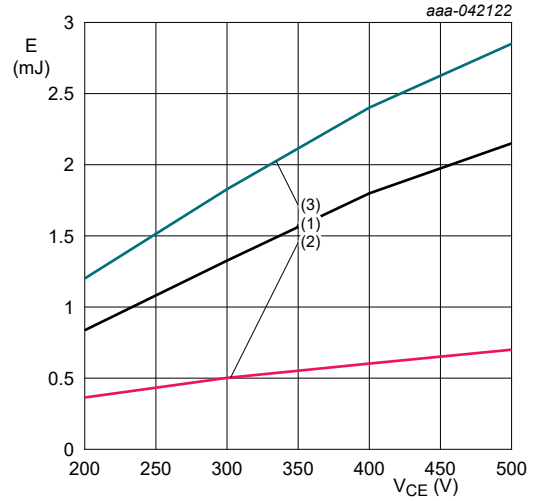
Fig. 16. Typical switching energy losses as a function of gate resistance





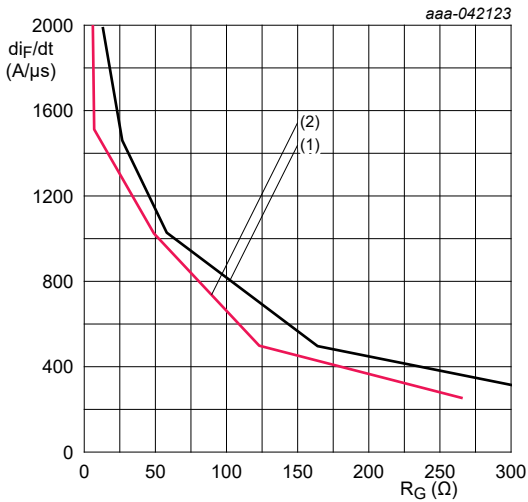
$V_{GE} = 15\text{ V to }0\text{ V}; I_C = 40\text{ A}; V_{CC} = 400\text{ V};$   
 $R_{G(on)} = 10\ \Omega; R_{G(off)} = 10\ \Omega$   
 (1)  $E_{on}$   
 (2)  $E_{off}$   
 (3)  $E_{ts}$

**Fig. 17. Typical switching energy losses as a function of junction temperature**



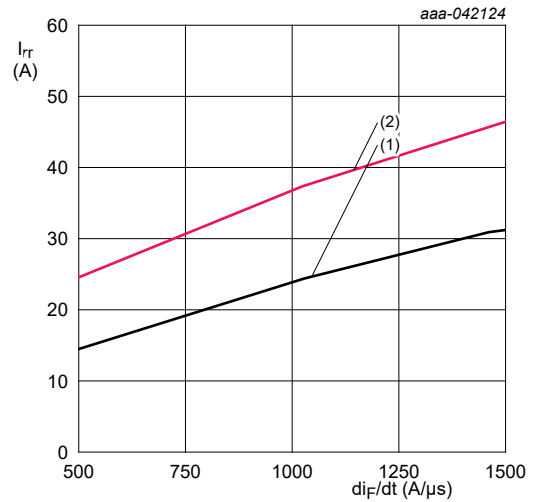
$V_{GE} = 15\text{ V to }0\text{ V}; I_C = 40\text{ A}; R_{G(on)} = 10\ \Omega;$   
 $R_{G(off)} = 10\ \Omega; T_{vj} = 175\text{ }^\circ\text{C}$   
 (1)  $E_{on}$   
 (2)  $E_{off}$   
 (3)  $E_{ts}$

**Fig. 18. Typical switching energy losses as a function of collector-emitter voltage**



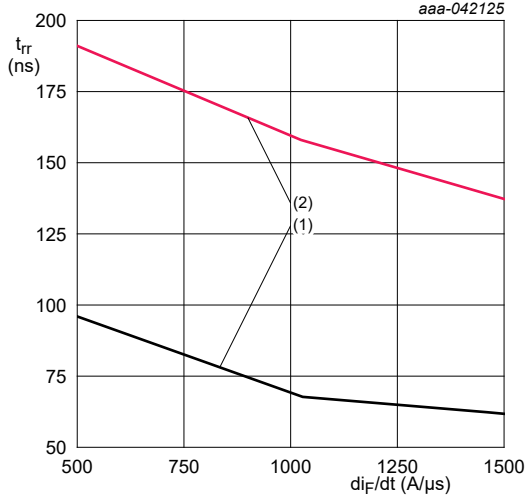
$V_R = 400\text{ V}; I_F = 20\text{ A}$   
 (1)  $T_{vj} = 25\text{ }^\circ\text{C}$   
 (2)  $T_{vj} = 175\text{ }^\circ\text{C}$

**Fig. 19. Typical rate of change of forward current as a function of change of gate resistance**



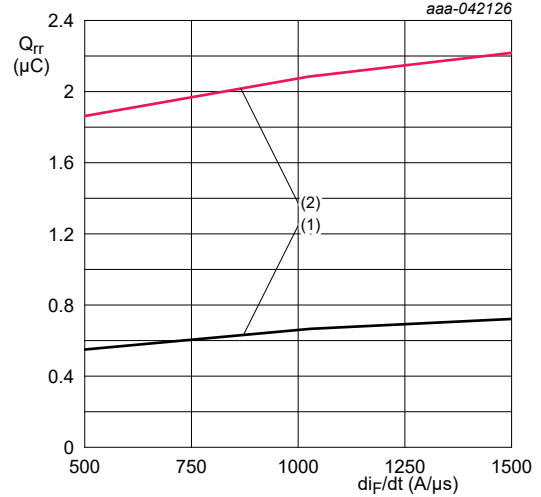
$V_R = 400\text{ V}; I_F = 20\text{ A}$   
 (1)  $T_{vj} = 25\text{ }^\circ\text{C}$   
 (2)  $T_{vj} = 175\text{ }^\circ\text{C}$

**Fig. 20. Typical reverse recovery current as a function of rate of change of forward current**



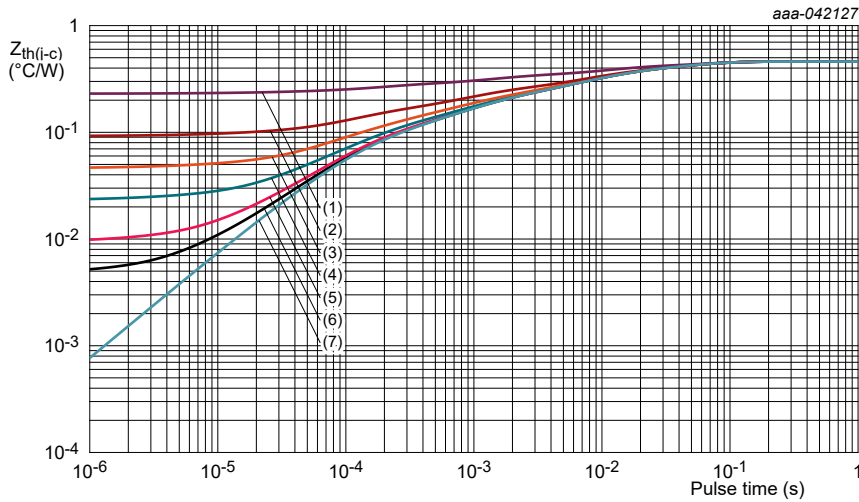
$V_R = 400 \text{ V}; I_F = 20 \text{ A}$   
 (1)  $T_{vj} = 25 \text{ }^\circ\text{C}$   
 (2)  $T_{vj} = 175 \text{ }^\circ\text{C}$

Fig. 21. Typical reverse recovery time as a function of rate of change of forward current



$V_R = 400 \text{ V}; I_F = 20 \text{ A}$   
 (1)  $T_{vj} = 25 \text{ }^\circ\text{C}$   
 (2)  $T_{vj} = 175 \text{ }^\circ\text{C}$

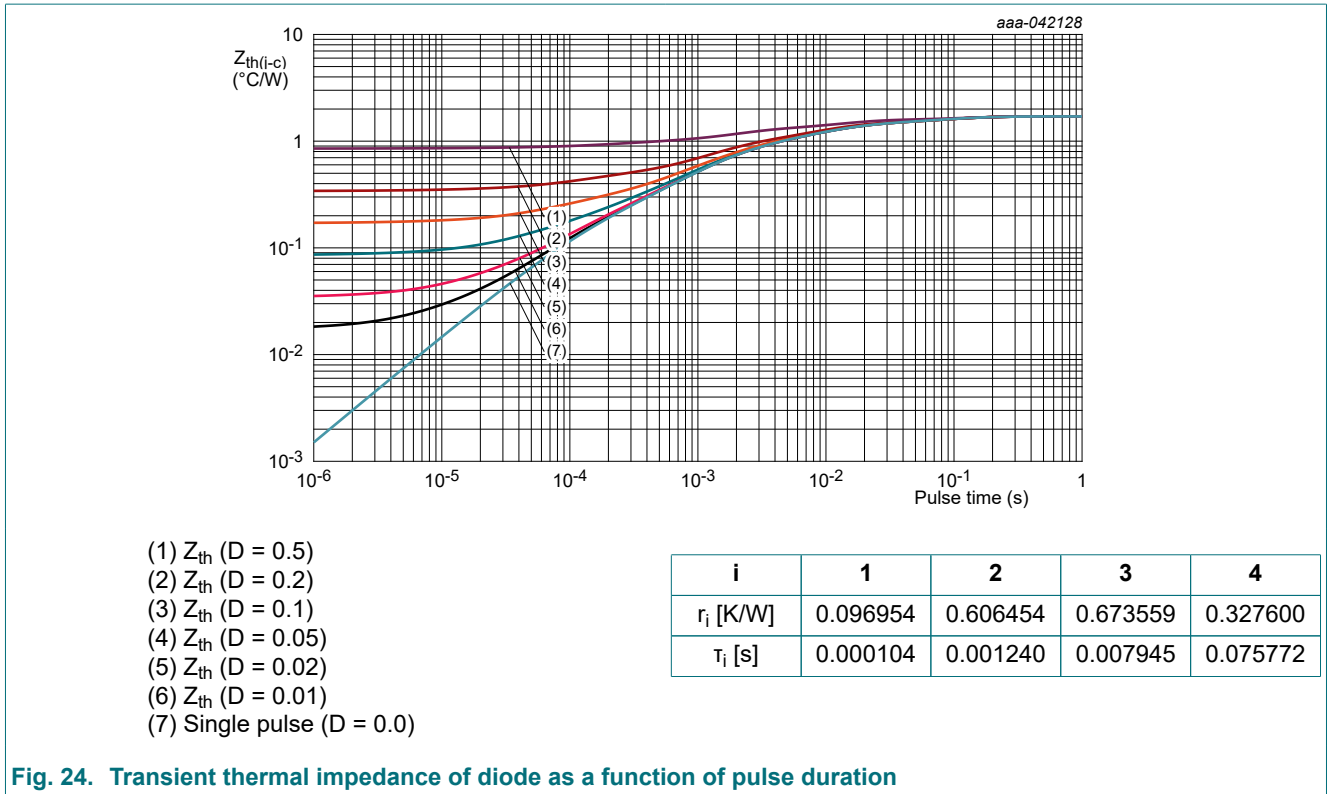
Fig. 22. Typical reverse recovery charge as a function of rate of change of forward current



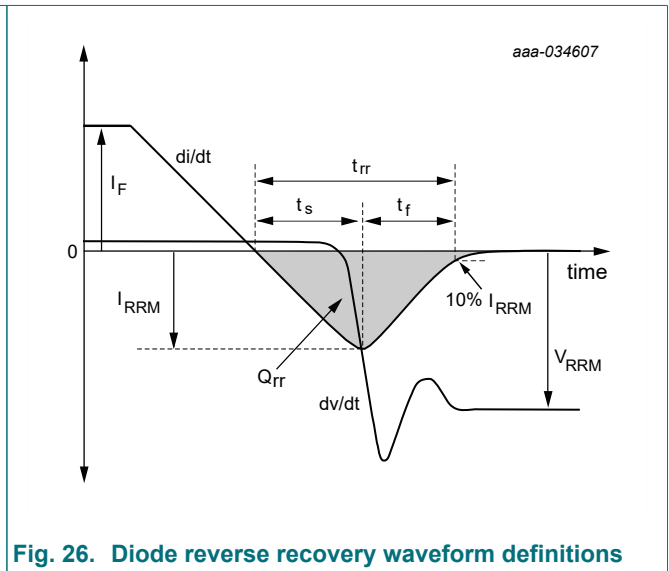
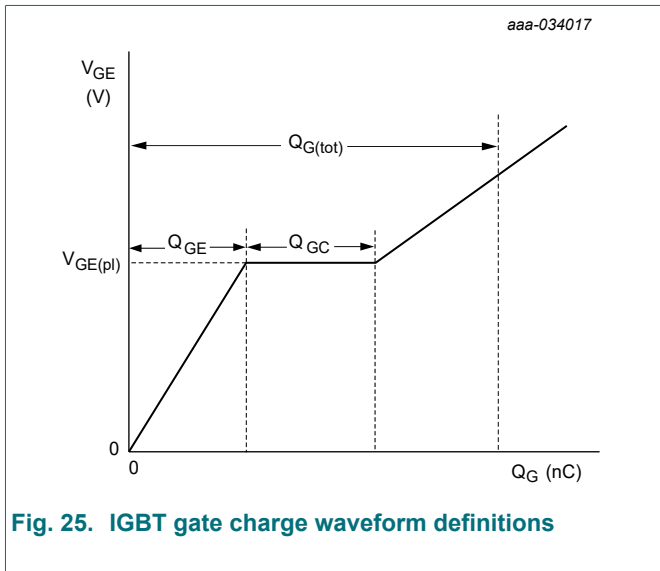
- (1)  $Z_{th} (D = 0.5)$
- (2)  $Z_{th} (D = 0.2)$
- (3)  $Z_{th} (D = 0.1)$
- (4)  $Z_{th} (D = 0.05)$
- (5)  $Z_{th} (D = 0.02)$
- (6)  $Z_{th} (D = 0.01)$
- (7) Single pulse ( $D = 0.0$ )

i	1	2	3	4
$r_i$ [K/W]	0.068497	0.107215	0.156203	0.128591
$\tau_i$ [s]	0.000112	0.000823	0.007026	0.039094

Fig. 23. Transient thermal impedance of IGBT as a function of pulse duration



### 9.2. Waveform definitions



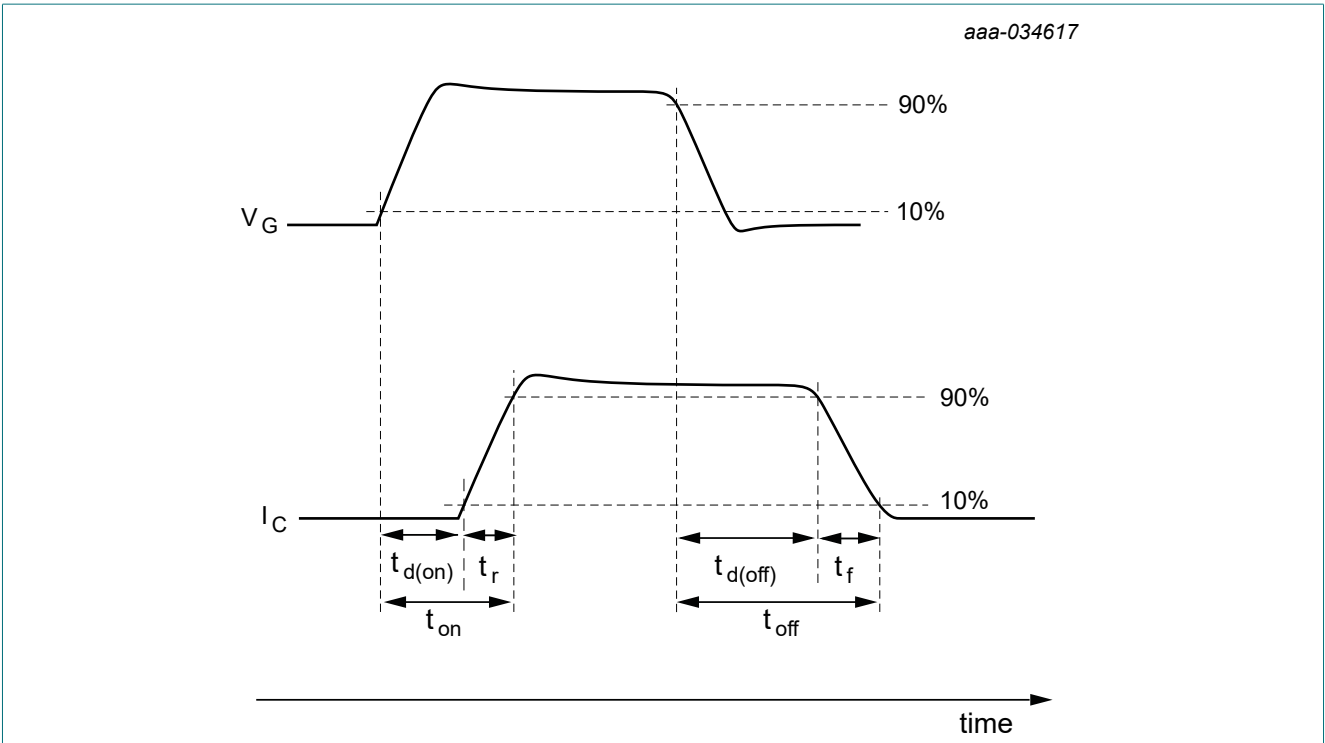
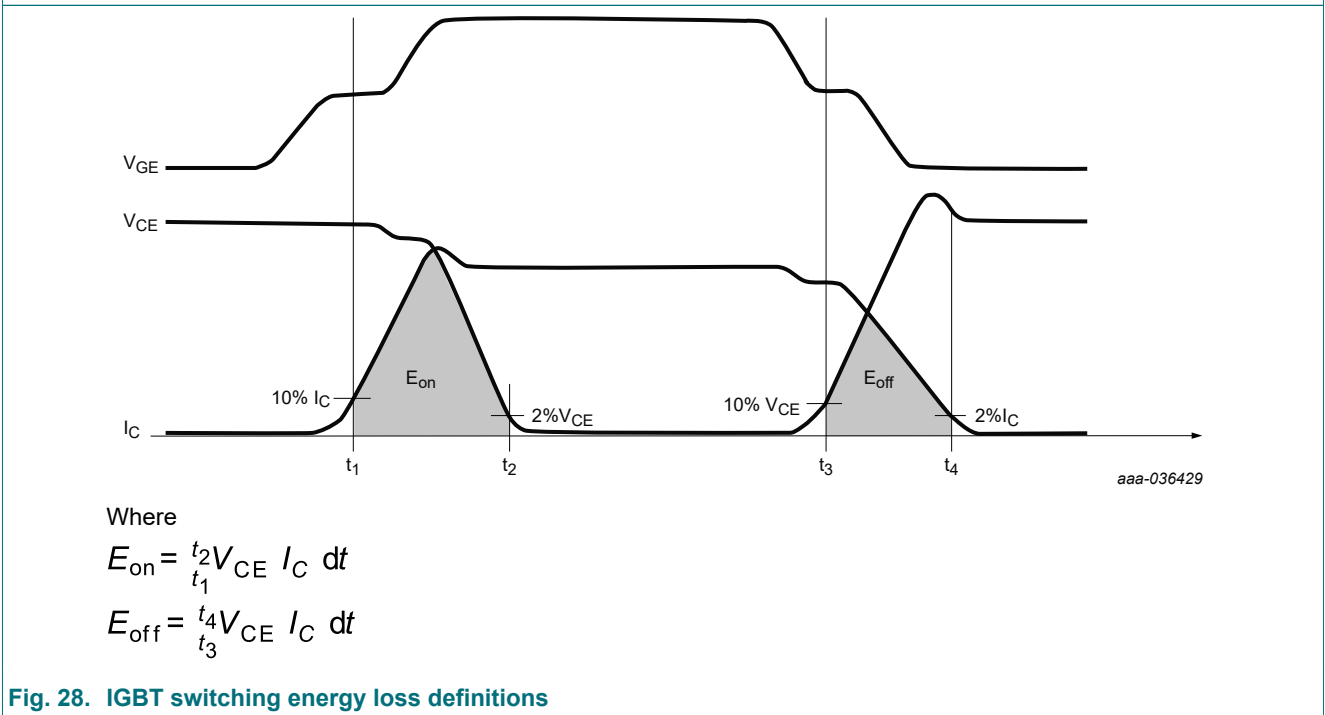


Fig. 27. IGBT switching times definitions



Where

$$E_{on} = \int_{t_1}^{t_2} V_{CE} I_C dt$$

$$E_{off} = \int_{t_3}^{t_4} V_{CE} I_C dt$$

Fig. 28. IGBT switching energy loss definitions

10. Package outline

Plastic single-ended through-hole package; heatsink mounted; 1 mounting hole; 3-lead TO-247-3L

SOT429-2

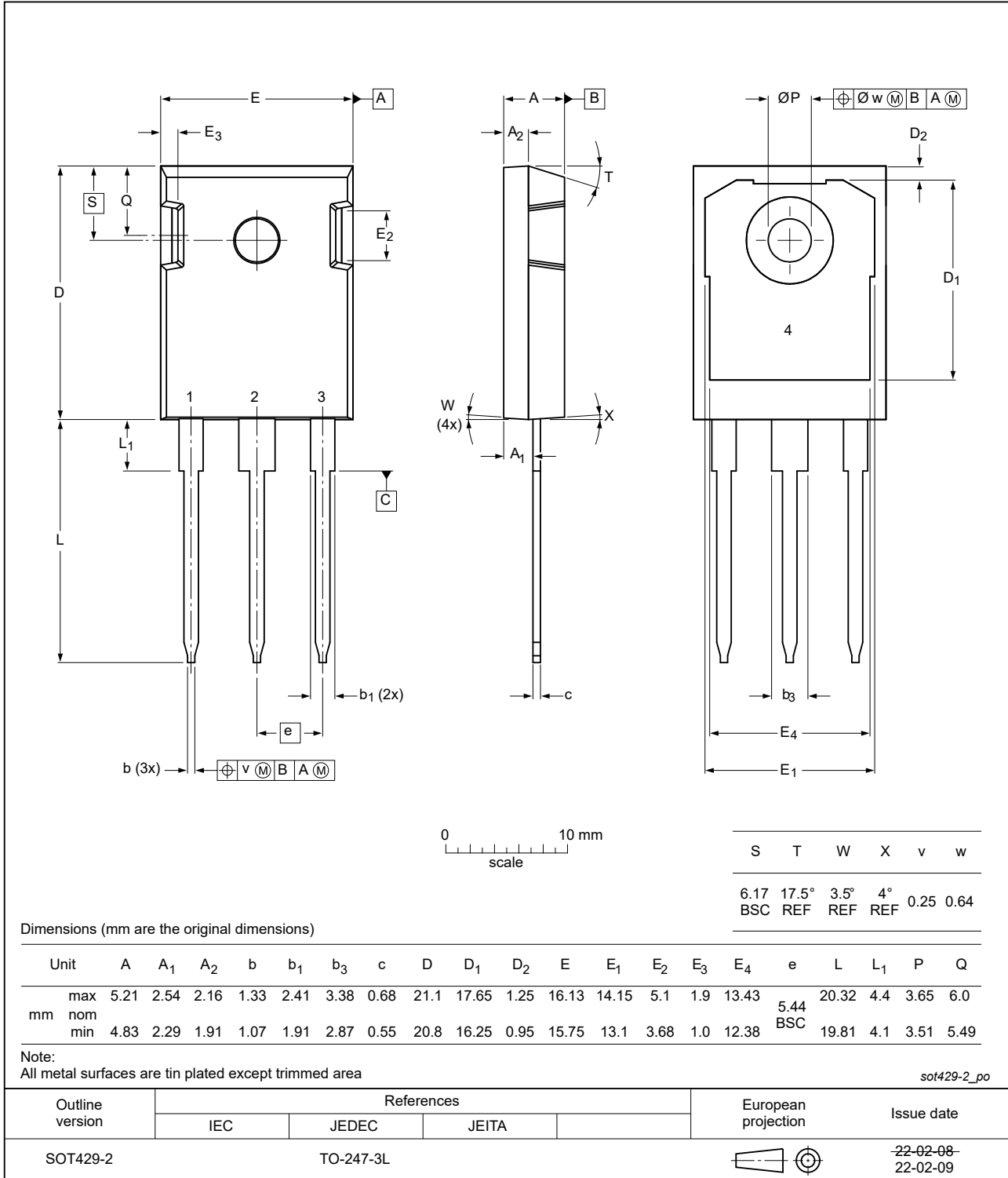


Fig. 29. Package outline TO-247-3L (SOT429-2)

# 11. Revision history

Table 8. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
NGW40T65H3DHP v. 1	20250117	Product data sheet	-	-

## 12. Legal information

### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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